

• General Description

The AGM056N08C combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$.

This device is ideal for load switch and battery protection applications.

Features

- Advance high cell density Trench technology
- Low R_{DS(ON)} to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

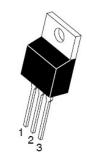
Application

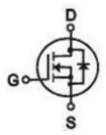
- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDSON	ID
85V	4.4mΩ	120A

TO-220 Pin Configuration





Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM056N08C	AGM056N08C	TO-220			1000

Table 1. Absolute Maximum Ratings (TC=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	85	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)		Α
	Drain Current-Continuous(Tc=100℃)	87.4	А
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 2)	480	Α
PD	Maximum Power Dissipation(Tc=25℃)	173.6	W
	Maximum Power Dissipation(Tc=100°ℂ)	69	w
EAS	Avalanche energy (Note 3)	306	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}$

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹		62.5	°C/W
RθJC	Thermal Resistance Junction-Case ¹		0.72	°C/W



Table 3. Electrical Characteristics (TC=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250µA	85			V
IDSS	Zero Gate Voltage Drain Current	VDS=85V,VGS=0V			1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250µA	2	3	4	V
gFS	Forward Transconductance	VDS=5V,ID=20A				S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=50A		4.4	5	mΩ
1.00(011)		VGS=4.5V, ID=40A				mΩ
Dynamic (Characteristics					
Ciss	Input Capacitance	VDS=42.5V,		4020		pF
Coss	Output Capacitance	VGS=0V,		607		pF
Crss	Reverse Transfer Capacitance	F=1MHZ		15		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz		1.7		Ω
Switching	Times					
td(on)	Turn-on Delay Time			22		nS
tr	Turn-on Rise Time	VGS=10V,VDS=42.5V,		42		nS
td(off)	Turn-Off Delay Time	ID=50A,RGEN=3Ω		48		nS
tf	Turn-Off Fall Time			25		nS
Qg	Total Gate Charge			80		nC
Qgs	Gate-Source Charge	VGS=42.5V, VDS=10V, ID=50A		23		nC
Qgd	Gate-Drain Charge			24		nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)				120	А
VSD	Forward on Voltage	VGS=0V,IS=50A			1.2	V
trr	Reverse Recovery Time	Is=20A , dI/dt=500A/µs ,		60		ns
Qrr	Reverse Recovery Charge	TJ=25℃		136		nc

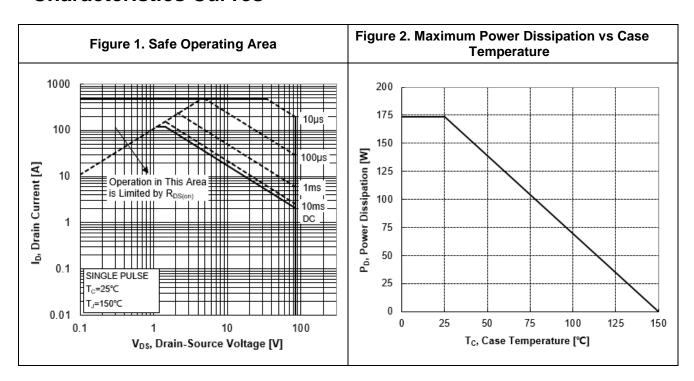
Notes 1.The maximum current rating is package limited.

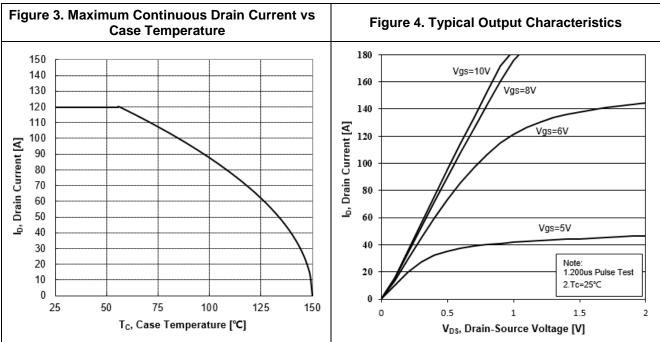
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25℃

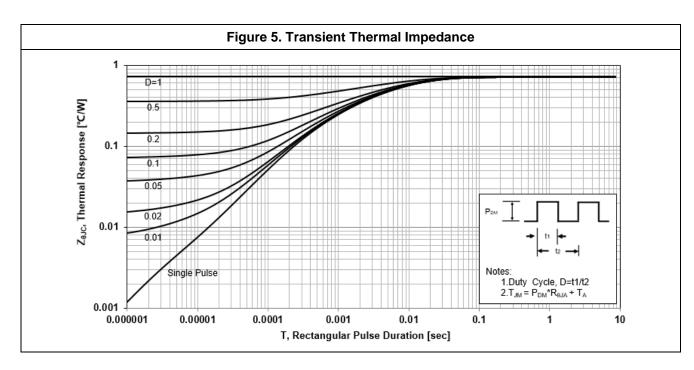


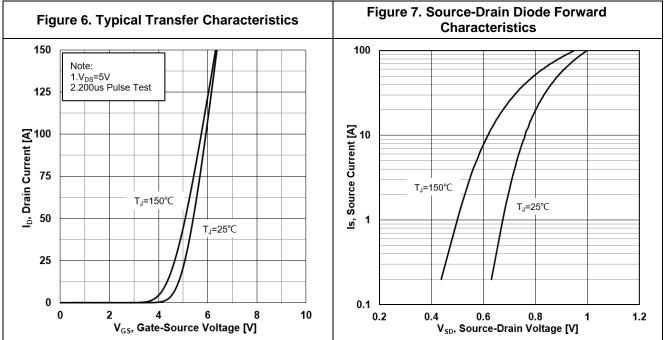
Characteristics Curves



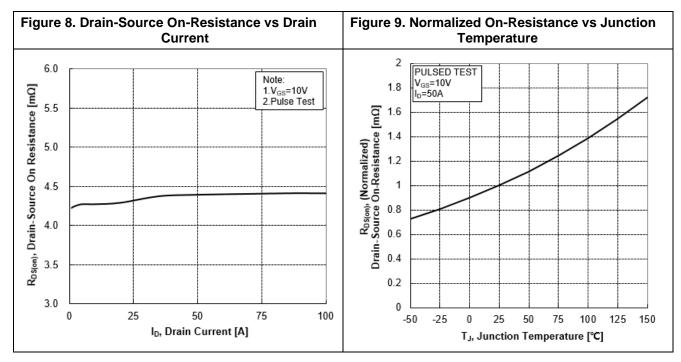


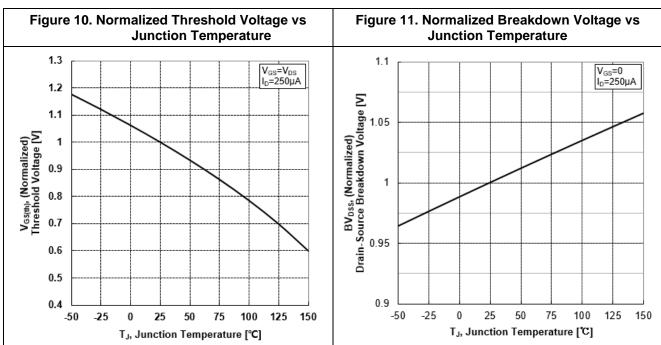














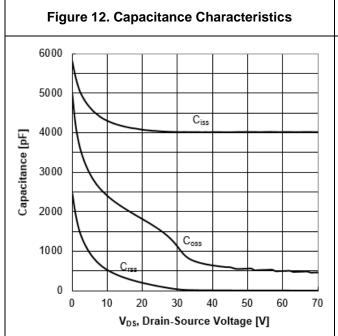


Figure 13. Typical Gate Charge vs Gate-Source Voltage

10

8

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Voltage

Voltage

Voltage

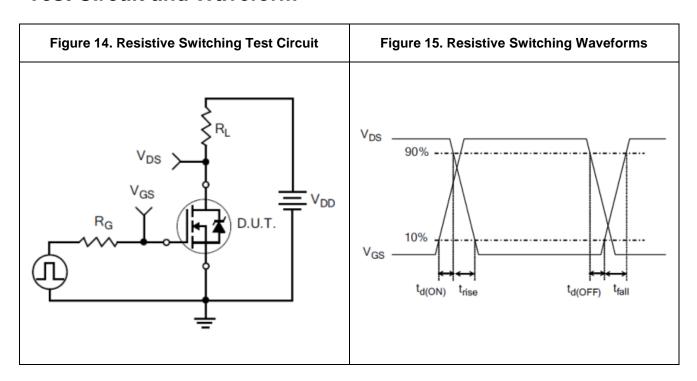
Voltage

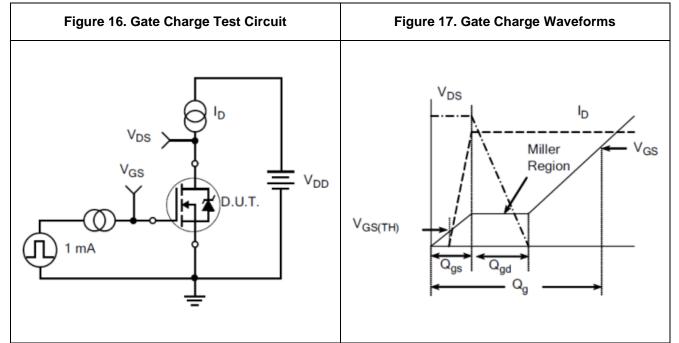
Voltage

Qg, Gate Charge [nC]

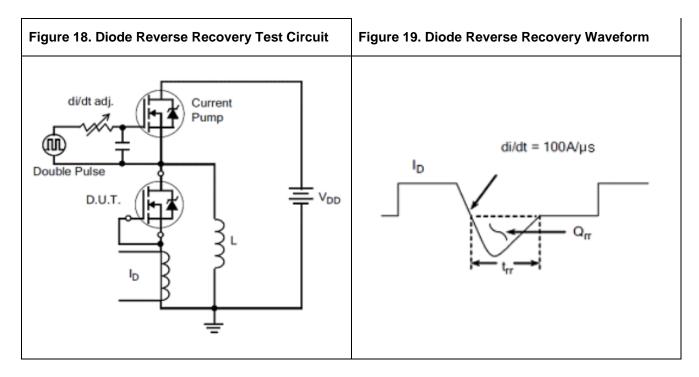


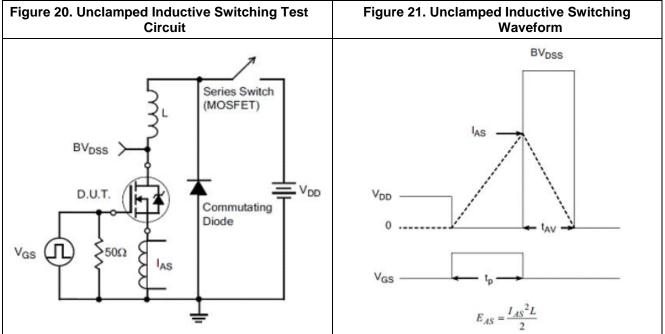
Test Circuit and Waveform





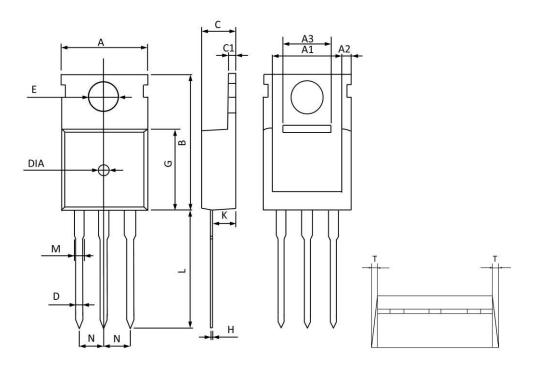








TO220 PACKAGE INFORMATION



Cross bol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	MAX	MIN	MAX	MIN	
A	10.300	9.700	0.406	0.382	
A1	8.840	8.440	0.348	0.332	
A2	1.250	1.050	0.049	0.041	
A3	5.300	5.100	0.209	0.201	
В	16.200	15.400	0.638	0.606	
C	4.680	4.280	0.184	0.169	
C1	1.500	1.100	0.059	0.043	
D	1.000	0.600	0.039	0.024	
E	3.800	3.400	0.150	0.134	
G	9.300	8.700	0.366	0.343	
Н	0.600	0.400	0.024	0.016	
K	2.700	2.100	0.106	0.083	
L	13.600	12.800	0.535	0.504	
M	1.500	1.100	0.059	0.043	
N	2.590	2.490	0.102	0.098	
T	W	W0.35		.014	
DIA	Ф1.5 ТҮР.	deep0.2 TYP.	Ф0.059 ТҮР.	deep0.008 TYP.	



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